

METAL SINGLE-IN-LINE MODULE

0.66 (16,76) MAX.
0.500 (12,70)

3.00 (76,20) MAX.

Note G

1

0.025 (0,63) TYP.
0.017 (0,43) TYP.
0.100 (2,54) TYP.

1.02 (25,90) MAX.

0.050 (1,27) TYP.
0.050 (1,27) TYP.

0.160 (4,06) TYP.

0.140 (3,55) MIN.
See Note F

0.050 (1,27)
0.110 (2,79)
0.70 (17,78)
0.040 (1,01)

3.028 (76,91)
2.928 (74,37)

Note E

0.54 (13,71)
0.350 (8,89)
0.090 (2,28) 2 Places

1

ø0.045 (1,14) MIN. 27 Places
Plated through

0.100 (2,54) 26 Places
0.164 (4,16)

ø0.093 (2,36) MIN. 4 Places
Plated through holes.
See Note G.

PC Layout

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- NOTES:
- A. All linear dimensions are in inches (mm).
 - B. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 ($\pm 0.76\text{mm}$).
 - D. 3 place decimals are ± 0.010 ($\pm 0.25\text{mm}$).
 - E. Recommended mechanical keep out area.
 - F. Electrical pin length mounted on printed circuit board, from seating plane to pin end.
 - G. The case may be electrically connected to power ground plane.

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